

VS3503AD-VB Datasheet

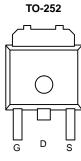
P-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a		
- 30	0.005 at V _{GS} = - 10 V	-100		
- 30	0.007 at V _{GS} = - 4.5 V	-90		

FEATURES

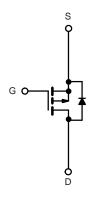
Compliant to RoHS Directive 2002/95/EC







Top View



P-Channel MOSFET

ABSOLUTE MAXIMUM RAT	103(1C = 23 C, utiless other	wise noteu)			
Parameter	Symbol	Limit	Unit		
Gate-Source Voltage	V _{GS}	± 20	V		
Continuous Drain Ourrent (T. 475 °C)	T _C = 25 °C		- 100 ^a		
Continuous Drain Current (T _J = 175 °C)	T _C = 125 °C	Ι _D	- 90	•	
Pulsed Drain Current	I _{DM}	- 280	- A		
Avalanche Current	I _{AR}	- 80			
Repetitive Avalanche Energy ^b	L = 0.1 mH	E _{AR}	180	mJ	
Pawer Dissinction	T _C = 25 °C (TO-220AB and TO-263)	D	187 ^d	w	
Power Dissipation	T _A = 25 °C (TO-263) ^c	PD	3.75		
Operating Junction and Storage Tempera	T _J , T _{stq}	- 55 to 175	°C		

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Limit	Unit	
Junction-to-Ambient	PCB Mount (TO-263) ^c	Р	40		
Junction-to-Ambient	Free Air (TO-220AB)	R _{thJA}	62.5	°C/W	
Junction-to-Case	·	R _{thJC}	0.8		

Notes:

a. Package limited.

b. Duty cycle \leq 1 %.

c. When mounted on 1" square PCB (FR-4 material).

d. See SOA curve for voltage derating.

* Pb containing terminations are not RoHS compliant, exemptions may apply.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	-1						
Drain-Source Breakdown Voltage V _{DS}		$V_{GS} = 0 V, I_{D} = -250 \mu A$	- 30			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1		- 3	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1	μΑ	
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = - 30 V, V_{GS} = 0 V, T_{J} = 125 °C			- 50		
		$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 175 \text{ °C}$			- 250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = -5 V, V_{GS} = -10 V$	- 120			А	
		V _{GS} = - 10 V, I _D = - 30 A		0.005		- Ω	
Drain-Source On-State Resistance ^a	Б	V_{GS} = - 10 V, I _D = - 30 A, T _J = 125 °C		0.006			
Drain-Source On-State Resistance	R _{DS(on)}	V_{GS} = - 10 V, I _D = - 30 A, T _J = 175 °C		0.008			
		V _{GS} = - 4.5 V, I _D = - 20 A		0.007			
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 75 A	20			S	
Dynamic ^b		· · · · ·					
Input Capacitance	C _{iss}			8000		pF	
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = - 25 V, f = 1 MHz		1565			
Reversen Transfer Capacitance	C _{rss}			715			
Total Gate Charge ^c	Qg			160	240	nC	
Gate-Source Charge ^c	Q _{gs}	V _{DS} = - 15 V, V _{GS} = - 10 V, I _D = - 75 A		32			
Gate-Drain Charge ^c	Q _{gd}			30			
Turn-On Delay Time ^c	t _{d(on)}			25	40	ns	
Rise Time ^c	tr	V _{DD} = - 15 V, R _I = 0.2 Ω		225	360		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong -75$ Å, $V_{GEN} = -10$ V, $R_g = 2.5 \Omega$		150	240		
Fall Time ^c	t _f			210	340		
Source-Drain Diode Ratings and Cha	racteristics ^b	(T _C = 25 °C)		•			
Continuous Current	ا _S				- 80	•	
Pulsed Current	I _{SM}				- 240	A	
Forward Voltage ^a	V _{SD}	I _F = - 75 A, V _{GS} = 0 V		- 1.2	- 1.5	V	
Reverse Recovery Time	t _{rr}			55	100	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = - 75 A, dl/dt = 100 A/μs		2.5	5	А	
Reverse Recovery Charge	Q _{rr}	1 1		0.07	0.25	μC	

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

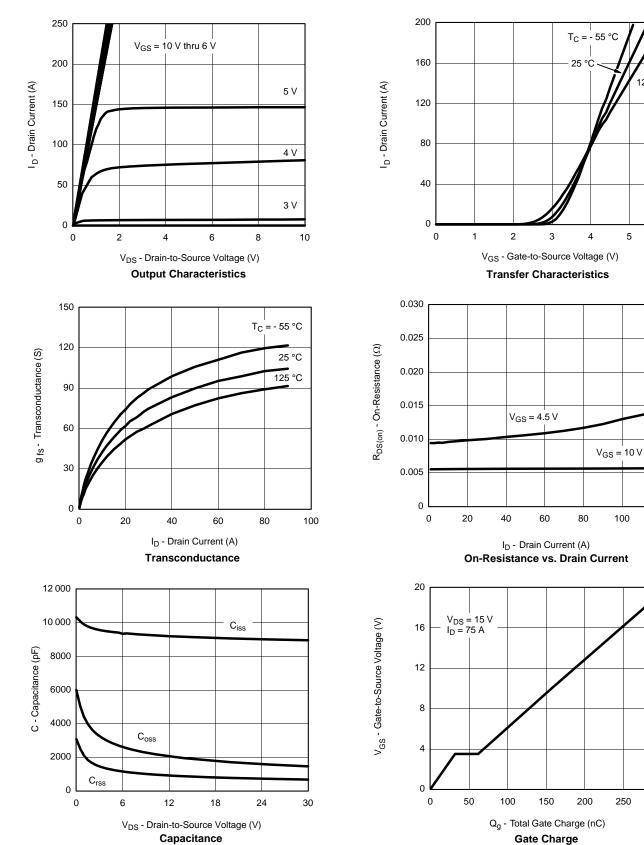
b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



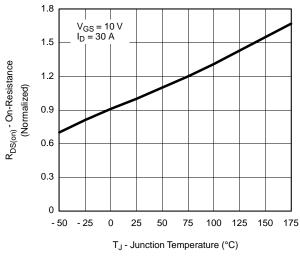
125 °C



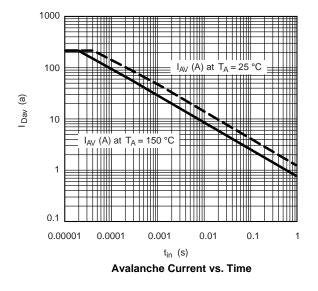
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

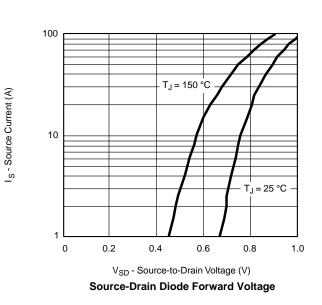


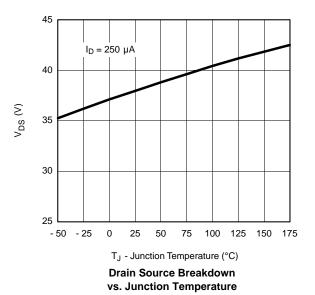
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



On-Resistance vs. Junction Temperature



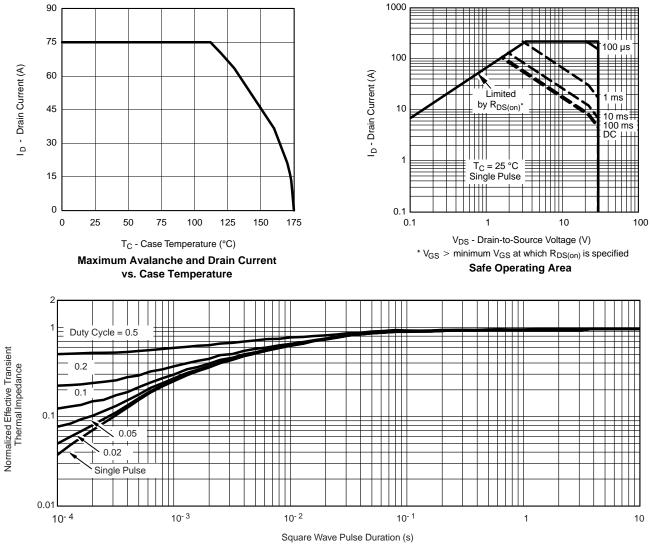




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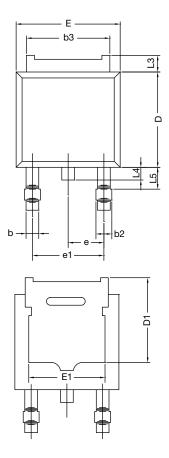
THERMAL RATINGS

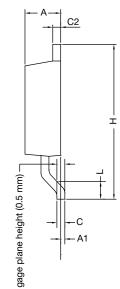


Normalized Thermal Transient Impedance, Junction-to-Case



TO-252AA CASE OUTLINE





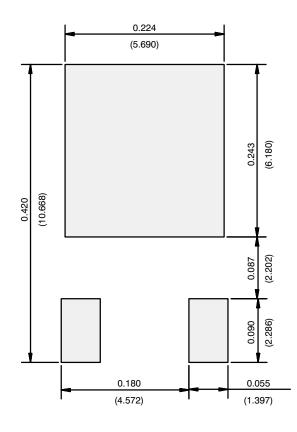
	MILLIN	IETERS	INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	5.21	-	0.205	-	
E	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28 BSC		0.090 BSC		
e1	4.56 BSC		0.180 BSC		
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.14	1.52	0.045	0.060	
ECN: X12-0247-Rev. M, 24-Dec-12 DWG: 5347					

Note

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)



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